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S/N: 10/799,685

6/8/2004

Docket No.: KAW-318-USAP

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Serial No.: 10/799,685 Confirmation No.: 8648

Applicant: Takashi ITO et al. Art Unit: 3729

Filed: March 15, 2004 Examiner: TO BE ASSIGNED

Docket No: KAW-318-USAP Customer No: 28892

For: Optical Device Molding Die Designing Method

INFORMATION DISCLOSURE STATEMENT PURSUANT TO 37 C.F.R. §§ 1.56, 1.97, and 1.98

US Patent & Trademark Office 2011 South Clark Place Customer Window Crystal Plaza Two, Lobby, Room 1B03 Arlington, VA 22202

Sir:

In compliance with the dictates of 37 C.F.R. §§ 1.56, 1.97, and 1.98, Applicant hereby submits an Information Disclosure Statement.

The attached document is mentioned in the present specification and a brief description of its relevance can be found therein.

It is respectfully requested that the Examiner consider this reference and indicate such consideration by enclosing an appropriately initialled copy of the enclosed form PTO-1449 with the next communication from the Patent Office.

Respectfully submitted,

Ronald R. Snider Attorney of Record Reg. No. 24,962

Date: June 8, 2004

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RRS/jt



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PTO FORM 1449 SUBMISSION

FOREIGN PATENT DOCUMENTS						
Examiner Initials*	Foreign Patent Document Number	Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY	T**		
	JP 2002-96344 English Abstract	Sony Corporation	April 2, 2002			

Examiner	Date	
Signature	Considered	

^{*}Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

^{**}Applicant is to place a check mark here if English language translation is attached